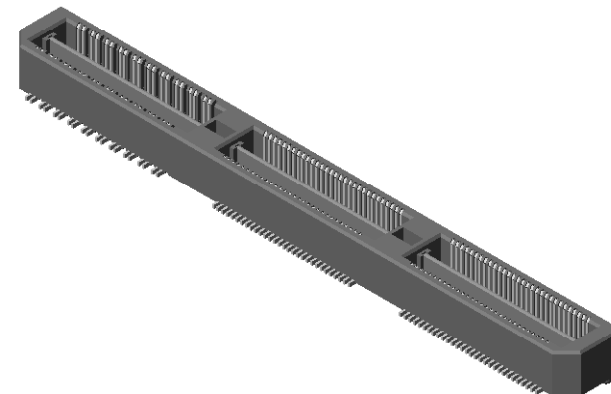


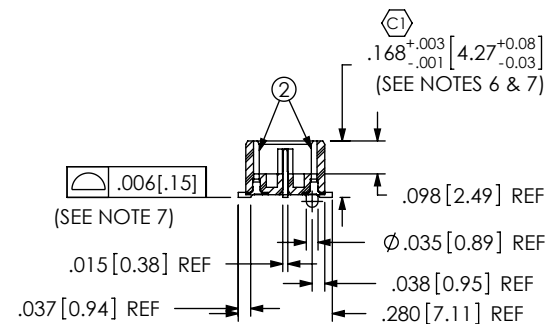
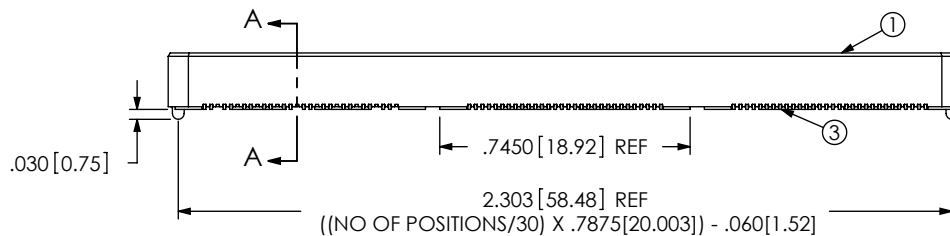
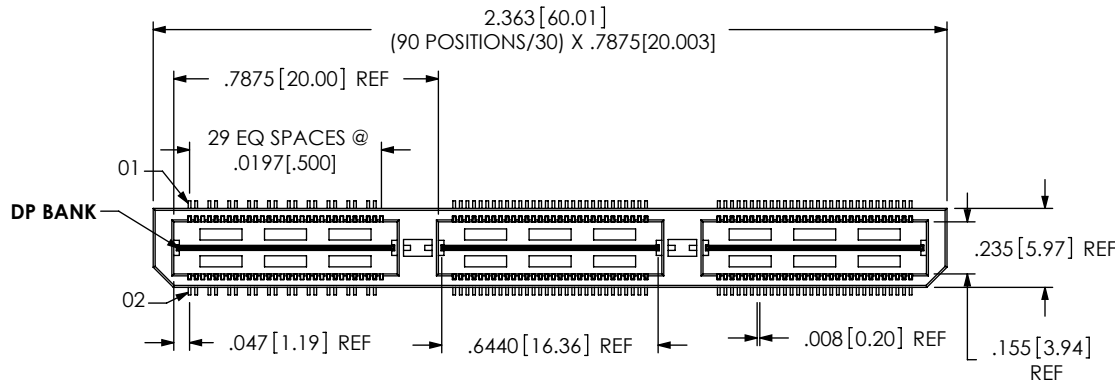
NOTES:

1. BANK 1 IS DIFFERENTIAL PAIR, BANK 2 & 3 ARE SINGLE ENDED.
2. Ⓢ REPRESENTS A CRITICAL DIMENSION.
3. MINIMUM PUSHOUT FORCE: 6 OZ.
4. MINIMUM GROUND PLANE RETENTION: 1 LB.
5. PARTS TO BE MOLDED TO POSITION.
6. MAXIMUM VARIANCE OF .002[.05] . APPLIES TO SIGNAL OR GROUNDS INDEPENDENT OF THE GROUND OR SIGNAL PINS RESPECTIVELY.
7. GROUND PLANE PRESS HEIGHT MUST BE .003[.07] LESS THAN THE MAXIMUM HEIGHT OR .002[.03] GREATER THAN THE MINIMUM HEIGHT OF SIGNAL PIN.
8. PARTS TO BE PACKAGED IN TRAYS.

DO NOT SCALE FROM THIS PRINT



SEE FOOT PRINT SHEET 2



SECTION "A"- "A"

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES. TOLERANCES ARE:
 DECIMALS ANGLES
 .XX: ±.01 [.3] 2°
 .XXX: ±.005 [.13]
 .XXXX: ±.0020 [.051]

PROPRIETARY NOTE
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 e-Mail: info@SAMTEC.com code: 55322

DO NOT SCALE DRAWING SHEET SCALE: 1.75:1
 GROUND PLANE & TERMINAL PLATING:
 CONTACT AREA: .000003 MIN GOLD OVER .000050-.000100 NICKEL
 REMAINDER: .000150-.000250 TIN OVER .000050-.000100 NICKEL

DESCRIPTION:
 .5MM DOUBLE ROW HS TERMINAL ASSEMBLY

DWG. NO. ASP-122952-01

BY: RRC 1/13/06 SHEET 1 OF 2

ITEM NO.	PART NUMBER	QUANTITY	MATERIAL
1	QTH-30-01-D-03-A	1.0000	VECTRA E130i, COLOR: BLACK
2	T-1S39-01-F	160.00	PHOS BRONZE, 510 SPRING TEMPER
3	T-1G1-01-F	3.0000	PHOS BRONZE, 510 HALF HARD TEMPER
4	TRAY-QXX-003-PR-01-APT-A	1.0000	ANTI-STATIC HIPS

